

PS8802-1,-2

1 Mbps HIGH CMR ANALOG OUTPUT TYPE 8-PIN SSOP (SO-8) HIGH-SPEED PHOTOCOUPLER R08DS0258EJ0100 Rev.1.00 Dec 9, 2021

DESCRIPTION

The PS8802-1, -2 are optically coupled isolators containing an AlGaAs LED on the light emitting diode (input side) and a PIN photodiode and a high-speed amplifier transistor on the output side on one chip.

The PS8802-1, -2 are designed specifically for high common mode transient immunity (CMR), the PS8802-2 is suitable for high density applications.

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FEATURES

- 40% reduction of mounting area (5-pin SOP × 2)
- High common mode transient immunity (CM_H, CM_L = ± 15 kV/ μ s MIN.)
- High supply voltage (Vcc = 35 V)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- High-speed response ($t_{PHL} = 0.8 \mu s MAX.$, $t_{PLH} = 1.2 \mu s MAX.$)
- Ordering number of tape product: PS8802-1-F3: 1 500 pcs/reel

: PS8802-2-F3 : 1 500 pcs/reel

- Pb-Free product
- Safety standards
 - UL : UL1577, Single protection
 - CSA: CAN/CSA-C22.2 No.62368-1, Basic insulation
 - VDE : DIN EN 60747-5-5 (Option)

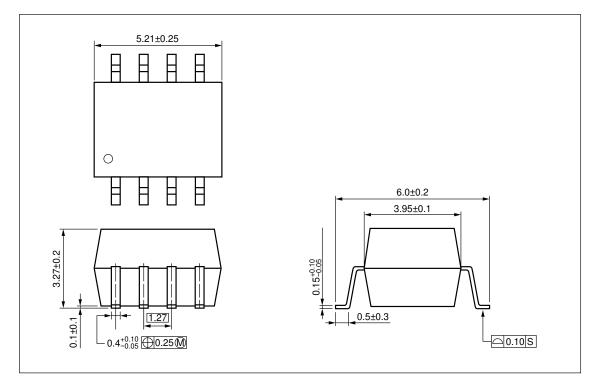
PIN CONNECTION (Top View) PS8802-1 1. NC 2. Anode 3. Cathode 4. NC 5. GND 6. V_O 7. NC 8. V_{CC} PS8802-2 1. Anode1 2. Cathode1 3. Cathode2 4. Anode2 5. GND 6. V_{O2} 7. V_{O1} $8. V_{CC}$

APPLICATIONS

- · Computer and peripheral manufactures
- General purpose inverter
- Substitutions for relays and pulse transformers
- Power supply

Start of mass production Nov.2003

PACKAGE DIMENSIONS (UNIT: mm)



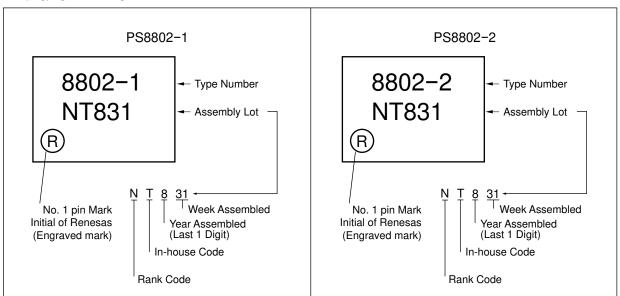
Weight: 0.14g (typ.)

PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	4 mm
Outer Creepage Distance	4 mm
Isolation Distance	0.2 mm

MARKING EXAMPLE

Ni/Pd/Au PLATING



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS8802-1	PS8802-1-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS8802-1
PS8802-1-F3	PS8802-1-F3-AX	-	Embossed Tape 1 500 pcs/reel	(UL, CSA approved)	
PS8802-2	PS8802-2-AX		20 pcs (Tape 20 pcs cut)		PS8802-2
PS8802-2-F3	PS8802-2-F3-AX		Embossed Tape 1 500 pcs/reel		
PS8802-1-V	PS8802-1-V-AX		20 pcs (Tape 20 pcs cut)	UL, CSA,	PS8802-1
PS8802-1-V-F3	PS8802-1-V-F3-AX		Embossed Tape 1 500 pcs/reel	DIN EN 60747-5-5 approved	
PS8802-2-V	PS8802-2-V-AX		20 pcs (Tape 20 pcs cut)		PS8802-2
PS8802-2-V-F3	PS8802-2-V-F3-AX		Embossed Tape 1 500 pcs/reel		

Notes*:1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

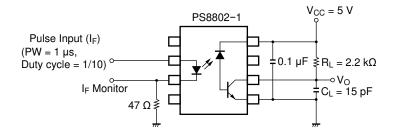
	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	lF	25	mA/ch
	Reverse Voltage	Vr	5.0	V/ch
	Power Dissipation*1	PD	45	mW/ch
Detector	Supply Voltage	Vcc	35	V
	Output Voltage	Vo	35	V/ch
	Output Current	lo	8.0	mA/ch
	Power Dissipation *2	Pc	100	mW/ch
Isolation V	Isolation Voltage *3		2 500	Vr.m.s.
Operating Ambient Temperature		TA	- 55 to + 100	°C
Storage Temperature		T _{stg}	- 55 to + 125	°C

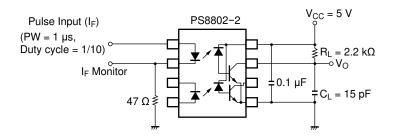
- Notes*: 1. Reduced to 0.45 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.
 - 2. Reduced to 1.00 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.
 - 3. AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output. Pins 1-4 shorted together, 5-8 shorted together.

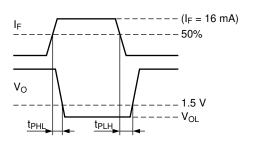
ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 16 mA		1.7	2.2	V
	Reverse Current	lπ	V _R = 3 V			10	μΑ
	Forward Voltage Temperature Coefficient	Δ V F/Δ T A	I _F = 16 mA		-2.1		mV/°C
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Detector	High Level Output Current	Іон (1)	$I_F = 0 \text{ mA}, V_{CC} = V_0 = 5.5 \text{ V}$		10	500	nA
	High Level Output Current	Іон (2)	IF = 0 mA, Vcc = Vo = 30 V			100	μΑ
	Low Level Output Voltage	Vol	IF = 16 mA, Vcc = 4.5 V, loL = 1.2 mA		0.1	0.4	V
	High Level Supply Current (PS8802-1)	Іссн	IF = 0 mA, Vo = open, Vcc = 30 V		0.1	2	μА
	High Level Supply Current (PS8802-2)				0.2	4	
(PS8802-1)	Low Level Supply Current (PS8802-1)	Iccl	IF = 16 mA, Vo = open, Vcc = 30 V		100		
	Low Level Supply Current (PS8802-2)				200		
Coupled	Current Transfer Ratio	CTR	IF = 16 mA, Vcc = 4.5 V, Vo = 0.4 V	15	25	45	%
	Input-Output Isolation Resistance	R _{I-O}	V _{I-O} = 1 kV _{DC} , RH = 40 to 60 %	1011			Ω
	Insulation Resistance (Input-Input), (PS8802-2)	Rı-ı	V _{I-I} = 1 kV _{DC} , RH = 40 to 60 %	10 ¹⁰			
	Input-Output Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.6		pF
	Insulation Capacitance (Input-Input), (PS8802-2)	C _{I-I}			0.3		
	Propagation Delay Time $(H \rightarrow L)^{*1}$	tрнL	IF = 16 mA, V_{CC} = 5 V, R_L = 2.2 k Ω , C_L = 15 pF		0.3	0.8	μѕ
	Propagation Delay Time $(L \rightarrow H)^{*1}$	tрLН			0.6	1.2	
	Common Mode Transient Immunity at High Level Output*2	СМн	eq:lemma:	15			kV/μs
	Common Mode Transient Immunity at Low Level Output ²	CM∟	IF = 16 mA, Vcc = 5 V, RL = 4.1 k Ω ,, VcM = 1.5 kV	-15			

Notes*: 1. Test circuit for propagation delay time

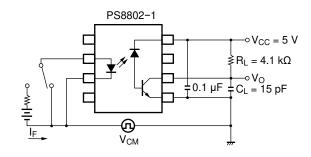


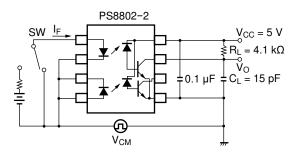


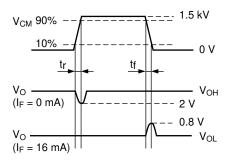


Remark: C_L includes probe and stray wiring capacitance.

2. Test circuit for common mode transient immunity







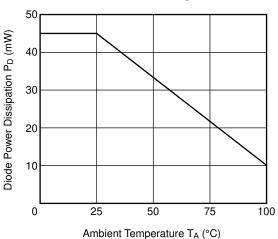
Remark: C_L includes probe and stray wiring capacitance.

USAGE CAUTIONS

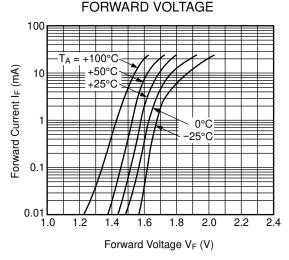
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.
- 4. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 5. Do not use fixing agents or coatings containing halogen-based substances.

TYPICAL CHARACTERISTICS (T_A = 25 °C unless otherwise specified)

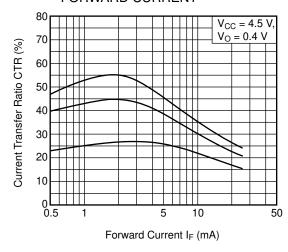




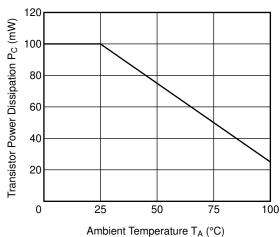
FORWARD CURRENT vs.



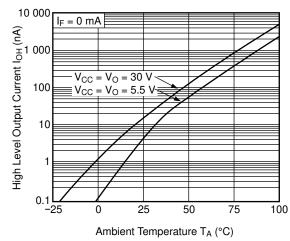
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



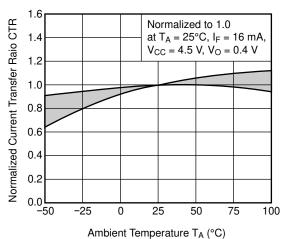
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



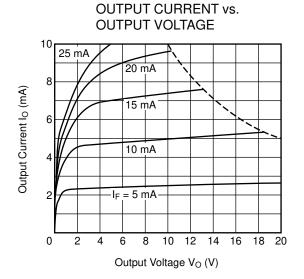
HIGH LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE



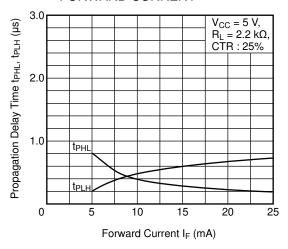
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



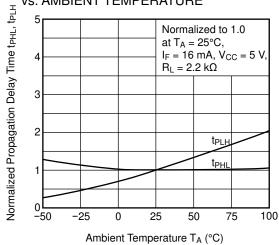
Remark The graphs indicate nominal characteristics.



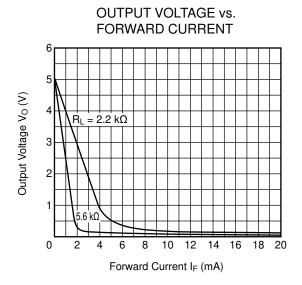
PROPAGATION DELAY TIME vs. FORWARD CURRENT



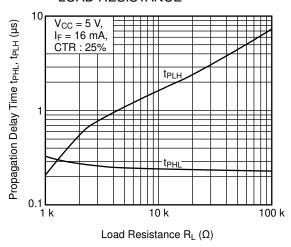
NORMALIZED PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



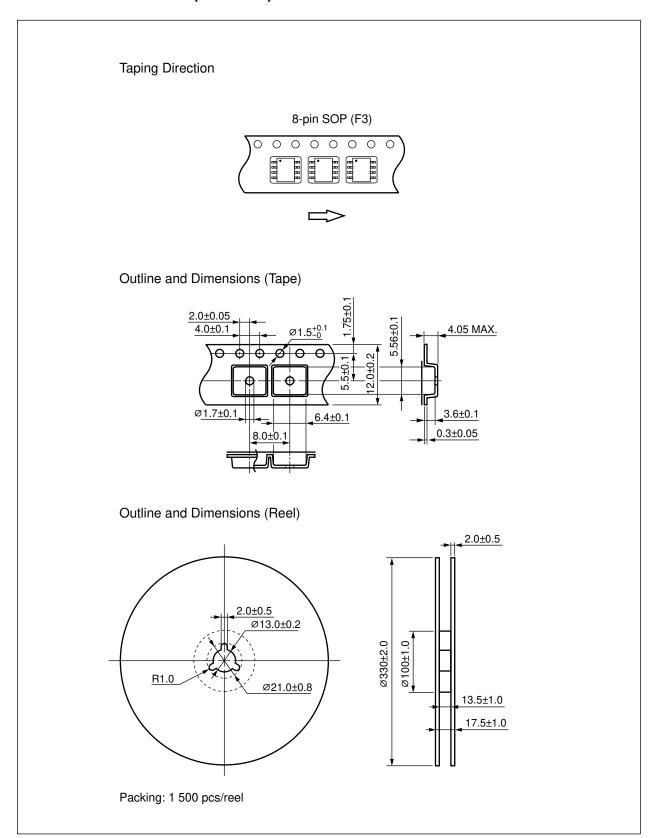
Remark The graphs indicate nominal characteristics.



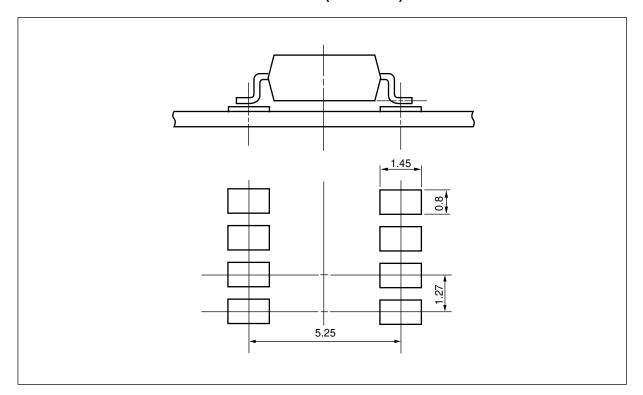
PROPAGATION DELAY TIME vs. LOAD RESISTANCE



TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

• Flux

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

 Peak reflow temperature 260 °C or below (package surface temperature)

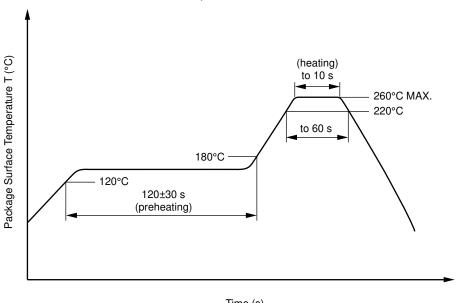
· Time of peak reflow temperature 10 seconds or less Time of temperature higher than 220 °C 60 seconds or less

• Time to preheat temperature from 120 to 180 °C $\,$ 120 \pm 30 s

Number of reflows

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260 °C or below (molten solder temperature)

 Time 10 seconds or less

· Preheating conditions 120 °C or below (package surface temperature)

One (Allowed to be dipped in solder including plastic mold portion.) Number of times • Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

 Peak Temperature (lead part temperature) 350 °C or below Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100 °C
- (4) Cautions
 - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

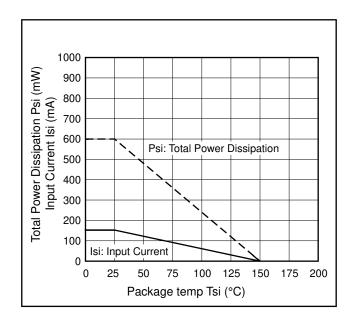
2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

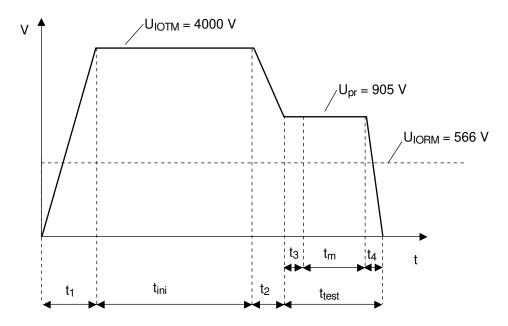
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM.}$, $P_d < 5$ pC	U _{IORM} U _{pr}	566 905	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM.}, P_d < 5 \; pC$	U_pr	1 061	V_{peak}
Highest permissible overvoltage	Uютм	4 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T_{stg}	- 55 to +125	°C
Operating temperature range	TA	- 55 to +100	°C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V}$ dc at $T_A = 25 ^{\circ}\text{C}$ $V_{IO} = 500 \text{ V}$ dc at T_A MAX. at least 100 $^{\circ}\text{C}$	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I_F , Psi = 0)	Tsi Isi	150 150	°C mA
Power (output or total power dissipation) Isolation resistance V _{IO} = 500 V dc at T _A = Tsi	Psi Ris MIN.	600 10 ⁹	mW O

Dependence of maximum safety ratings with package temperature



Method a) Destructive Test, Type and Sample Test



 t_1 , $t_2 = 1$ to 10 sec

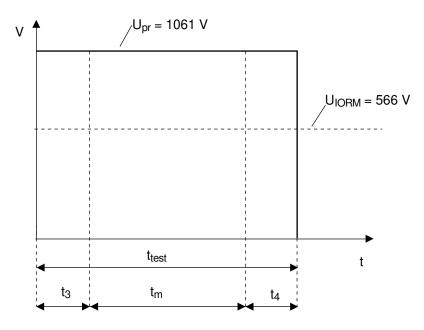
 $t_3, t_4 = 1 \text{ sec}$

 $t_{m(PARTIAL\ DISCHARGE)} = 10\ sec$

 $t_{test} = 12 sec$

 $t_{ini} = 60 \text{ sec}$

Method b) Non-destructive Test, 100% Production Test



 t_3 , $t_4 = 0.1 sec$

 $t_{m(PARTIAL\ DISCHARGE)} = 1.0\ sec$

 $t_{test} = 1.2 \text{ sec}$

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or i any way allow it to enter the mouth.

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